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Data Sheets (1)



MT53B256M32D1, MT53B512M32D2, MT53B1024M32D4

File Type: PDF Updated: 07/2018

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Data Sheet

DRAM Embedded Mobile LPDDR4

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# Specs

Orderable Parts for: MT53B512M32D2NP-062 WT

	Status	Media	FBGA Code	SPD Data	Chipset Validation	PLP	Start Date	Alternative Part
MT53B512M32D2NP-062 WT:C	Production	N/A	D9TFW	N/A	N/A	No		N/A

## Sim Models & Software

Sim Models



Mobile LPDDR4

DRAM



## **Z01M HSPICE (ZIP)**

DRAM Mobile LPDDR4

Z01M Mobile LPDDR4 SDRAM, Die Rev. C

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## **RoHS** Certificates

### **RoHS Certificates**

### **RoHS Certificate of Compliance (PDF)**

Part-specific certification of how this product meets the requirements of the current DIRECTIVE 2002/95/EC, a.k.a. Restriction of Hazardous Substances (RoHS) Directive.

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## **RoHS Certificates**

### **China RoHS Certificate (PDF)**

Part-specific certification as required by China's Management Methods for Controlling Pollution by Electronic Information Products.

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**Technical Notes** 

**SEARCH (81) TECHNICAL NOTES** 

#### Technical Notes

## **TN-ED-04: GDDR6 Design Guide (PDF)**

This technical note is designed to help designers implement GDDR6 as an off-the-shelf memory with established packaging, handling and testing. It outlines best practices for signal and power integrity, as well as standard GDDR6 DRAM features, to help system designs achieve the...

DRAM GDDR6N Graphics Performance

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## TN-53-06: LPDDR4 Point-to-Point Design Guidelines (PDF)

DRAM Mobile LPDDR4

(TN-53-06) Proven layout and routing techniques are required for embedded and mobile designs using point-to-point DRAM interfaces in side by side (non-PoP) configurations . Derived from transmission line theory and Micron design experience, the guidelines presented in this technical note...

File Type: PDF

**Updated: 03/16/2018** 

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## Parts with the same Data Sheet (5)

MT53B512M32D2NP-062 WT

(Current)

MT53B256M32D1NP-062 WT

MT53B256M32D1DS-062 XT

MT53B256M32D1NP-053 WT

MT53B512M32D2NP-062 WT

(Current)

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